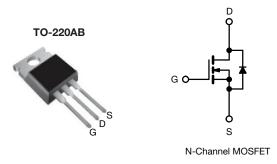
SiHP22N60AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.156			
Q _g max. (nC)	96				
Q _{gs} (nC)	12				
Q _{gd} (nC)	25				
Configuration	Single				

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION Package TO-220AB

	Package	TO-220AB
	Lood (Db) free and belegen free	SiHP22N60AE-BE3 ^a
Lead (Pb)-free and halogen-free	Lead (PD)-free and halogen-free	SiHP22N60AE-GE3

Note

a. "-BE3" denotes alternate manufacturing location

ABSOLUTE MAXIMUM RATINGS ($T_{\rm C}$	$= 25^{\circ}$ C, uni	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage Gate-source voltage			V _{DS}	600	v	
			V _{GS}	± 30	v	
Continuous drain current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		20		
	VGS at 10 V	T _C = 100 °C	I _D	12	А	
Pulsed drain current ^a			I _{DM}	49		
Linear derating factor				1.4	W/°C	
Single pulse avalanche energy ^b			E _{AS}	204	mJ	
Maximum power dissipation			PD	179	W	
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope	$T_J = 1$	T _J = 125 °C		70		
Reverse diode dV/dt ^d			dV/dt	31	V/ns	
Soldering recommendations (peak temperature) ^c	For	10 s		300	°C	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 3.8 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62				
Maximum junction-to-case (drain)	R _{thJC}	-	- 0.7			°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,	unless otherw	ise noted)						
PARAMETER	SYMBOL		T CONDITION	S	MIN.	TYP.	MAX.	UNI
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250	μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D =	250 µA	-	0.72	-	V/°(
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250	μA	2	-	4	V
		$V_{GS} = \pm 20 \text{ V}$		-	-	± 100	nA	
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
Zere este alle est i di i	L	V _{DS} =	= 600 V, V _{GS} =	0 V	-	-	1	
Zero gate voltage drain current	IDSS	V _{DS} = 480 \	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{\text{J}} = 125 ^{\circ}\text{C}$			-	10	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 11 A		-	0.156	0.180	Ω	
Forward transconductance	g _{fs}	V _{DS} = 30 V, I _D = 11 A		-	4.8	-	S	
Dynamic						-		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ $f = 1 MHz$ $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	1451	-	pF	
Output capacitance	C _{oss}			-	73	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}			-	50	-		
Effective output capacitance, time related ^b	C _{o(tr)}			-	258	-		
Total gate charge	Qg	V _{GS} = 10 V I _D = 11 A, V _{DS} = 480 V		-	48	96	nC	
Gate-source charge	Q _{gs}			-	12	-		
Gate-drain charge	Q _{gd}				-	25	-	1
Turn-on delay time	t _{d(on)}		•		-	19	38	
Rise time	t _r	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 11 \text{ A},$		-	33	66		
Turn-off delay time	t _{d(off)}		$V_{DD} = 480 \text{ V}, \text{ ID} = 11 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	45	90	ns
Fall time	t _f			-	21	42		
Gate input resistance	Rg	f = 1 MHz, open drain		0.3	0.6	1.2	Ω	
Drain-Source Body Diode Characterist	ics							
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	20	- A	
Pulsed diode forward current	I _{SM}			-	-	49		
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 11 A, V _{GS} = 0 V		-	-	1.2	V	
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 11 \text{ A}, \\ dI/dt = 100 \text{ A}/\mu\text{s}, V_{R} = 25 \text{ V}$		-	319	638	n	
Reverse recovery charge	Q _{rr}			-	4.9	9.8	μ	
Reverse recovery current	I _{RRM}			_	28	-	A	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDSS

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

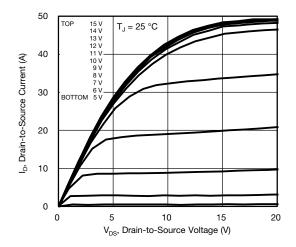


Fig. 1 - Typical Output Characteristics

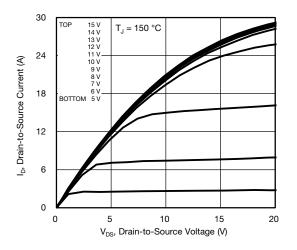
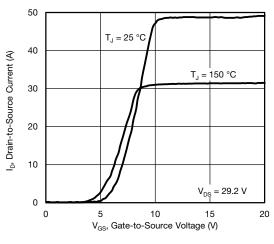


Fig. 2 - Typical Output Characteristics





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3.0 = 11 A R_{DS(on)}, Drain-to-Source On-Resistance 2.5 2.0 (Normalized) 1.5 1.0 10 \ GS 0.5 0 -20 -60 -40 20 40 60 80 100 120 140 160 0 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

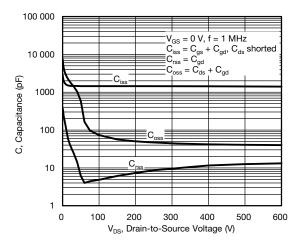
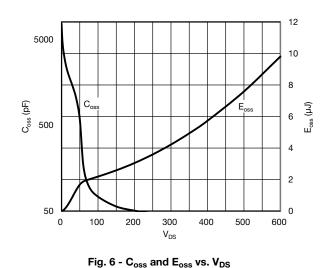


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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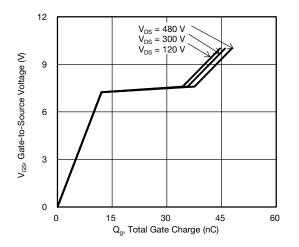


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

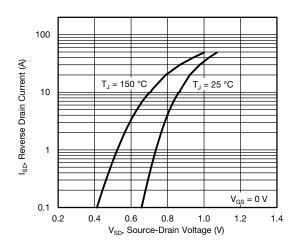


Fig. 8 - Typical Source-Drain Diode Forward Voltage

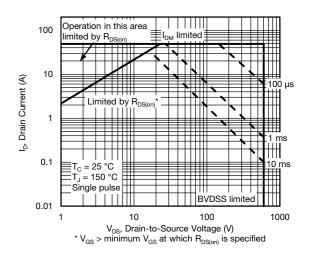


Fig. 9 - Maximum Safe Operating Area

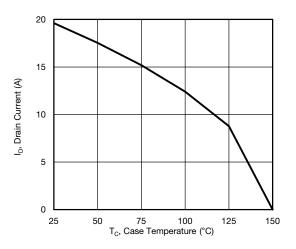


Fig. 10 - Maximum Drain Current vs. Case Temperature

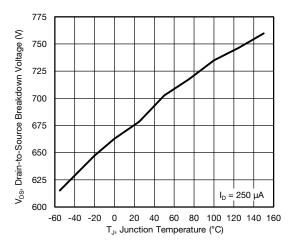


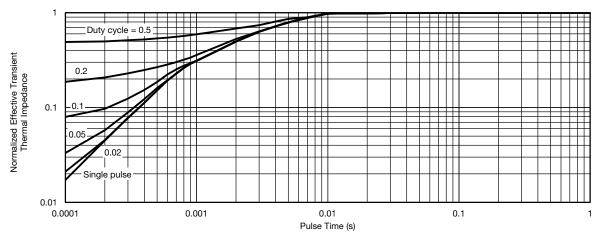
Fig. 11 - Temperature vs. Drain-to-Source Voltage

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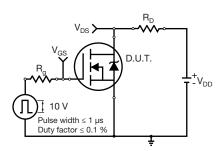


Fig. 13 - Switching Time Test Circuit

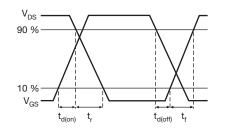


Fig. 14 - Switching Time Waveforms

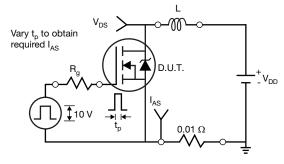


Fig. 15 - Unclamped Inductive Test Circuit

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Fig. 16 - Unclamped Inductive Waveforms

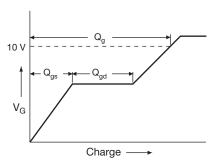
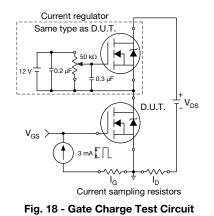
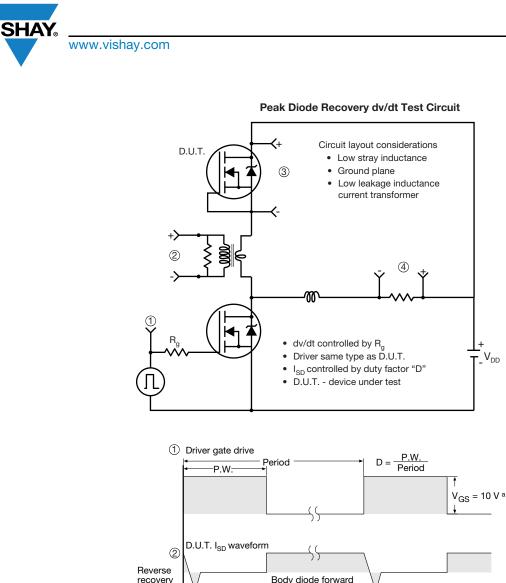


Fig. 17 - Basic Gate Charge Waveform



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current

Re-applied voltage

3

4

Note

D.U.T. V_{DS} waveform

Inductor current

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a. V_{GS} = 5 V for logic level devices Fig. 19 - For N-Channel

Ripple ≤ 5 %

current

Body diode forward drop

Diode recovery dv/dt

di/dt

VDD

↑ I_{SD}

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